

# Micromegas for imaging calorimetry



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# Overview

1. Micromegas semi-digital HCAL for future linear colliders  
Where do we stand in the CALICE technology tree?
2. Large size chambers for the active layers of an SDHCAL  
How do we built Micromegas chambers of 1 m<sup>2</sup> ?
3. Achieved performance  
Noise, response to MIPs and hadron showers
4. Conclusions and prospects towards LC-like modules

# Calorimetry at a future linear collider

## Physics case for an e<sup>+</sup>/e<sup>-</sup> collider

EWSB mechanism, SM precision measurement, SUSY spectrum

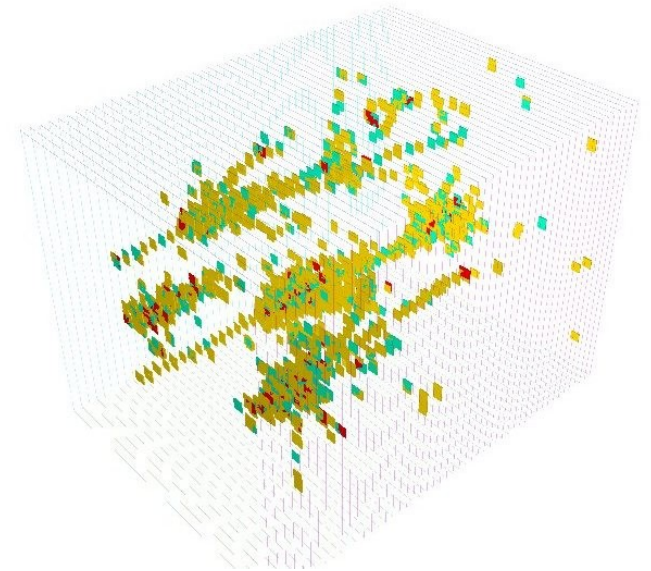
→ **Very demanding on calorimetry.**

**At 500 GeV ILC: jet energy scale of ~ 100 GeV**

Often quoted benchmark:

Separation of hadronic decays of di-boson final states

→ **Jet energy resolution of 30% /  $\sqrt{E}$  [GeV]**



## Dual readout approach

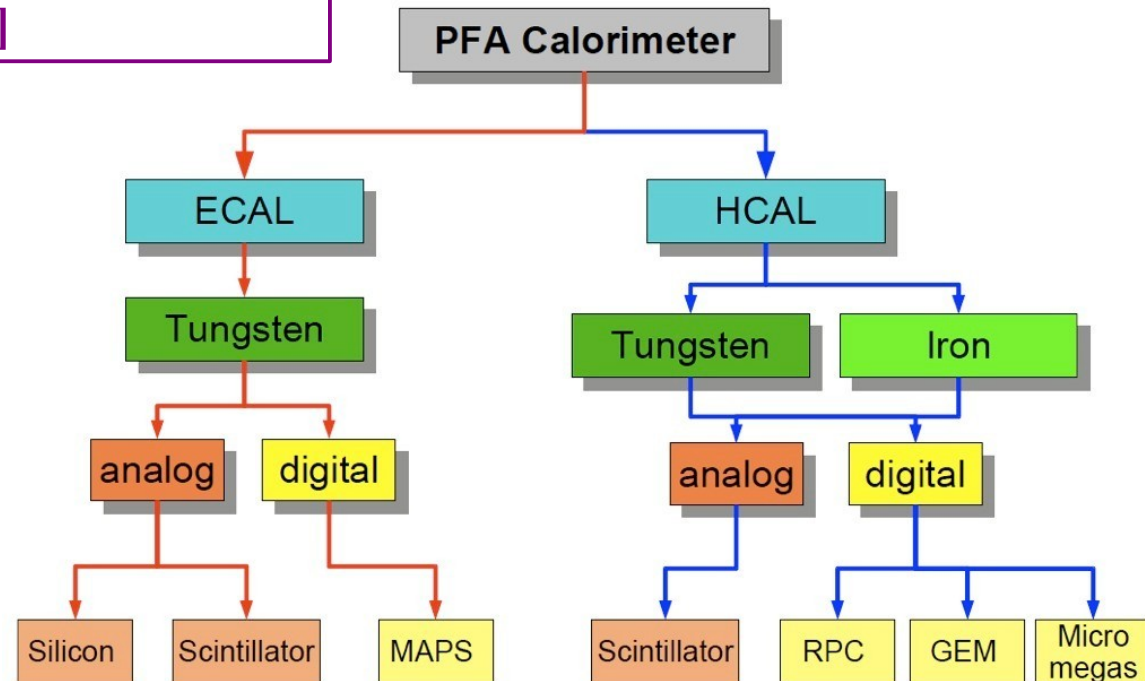
Push calorimeter standalone performance to its limit

→ **DREAM project**

## Particle Flow approach

Turn calorimeter into an imaging device

→ **CALICE projects**

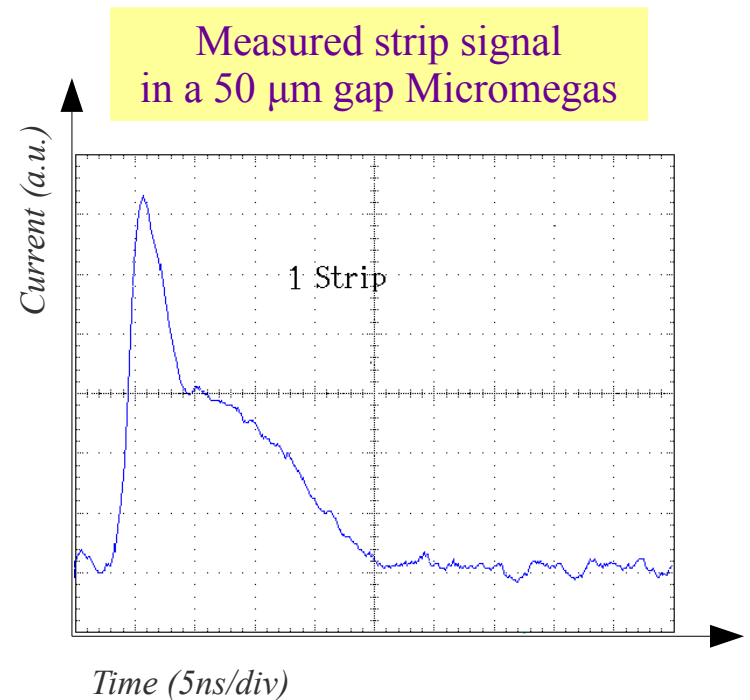
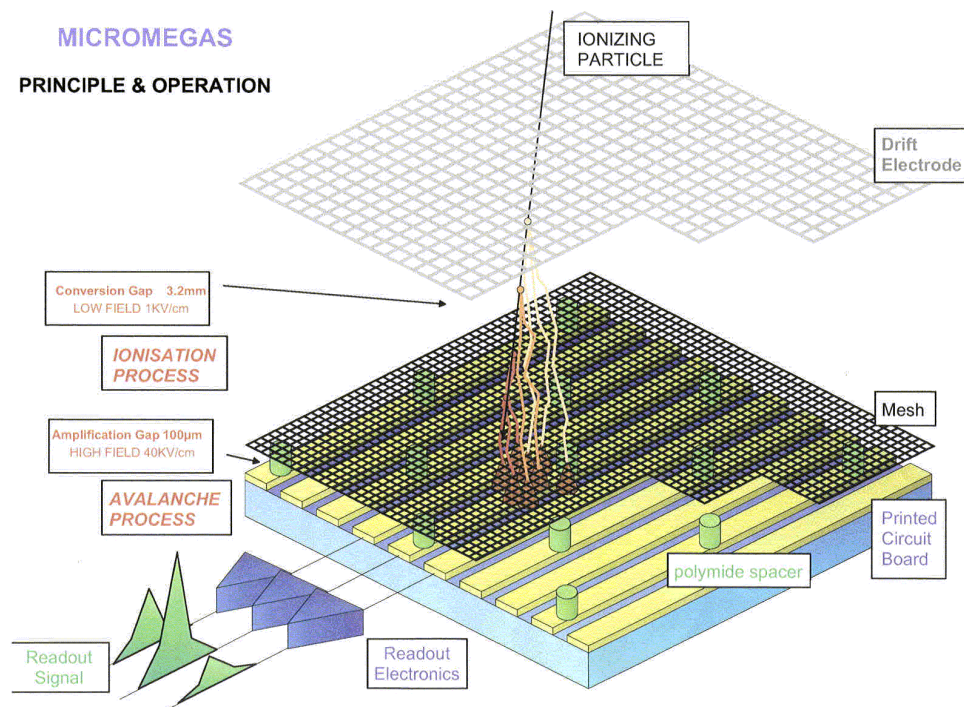


# Micromegas operation principle

**Primary ionisation** (in 3 mm Ar): follows Landau distribution, on average 30  $e^-$

**Drift of primary  $e^-$  towards mesh**, takes 50-100 ns

**Multiplication of primary  $e^-$**  by factors up to a few  $10^4$  in 1/100 ns for  $e^-/i^+$  (for a 128  $\mu\text{m}$  gap)



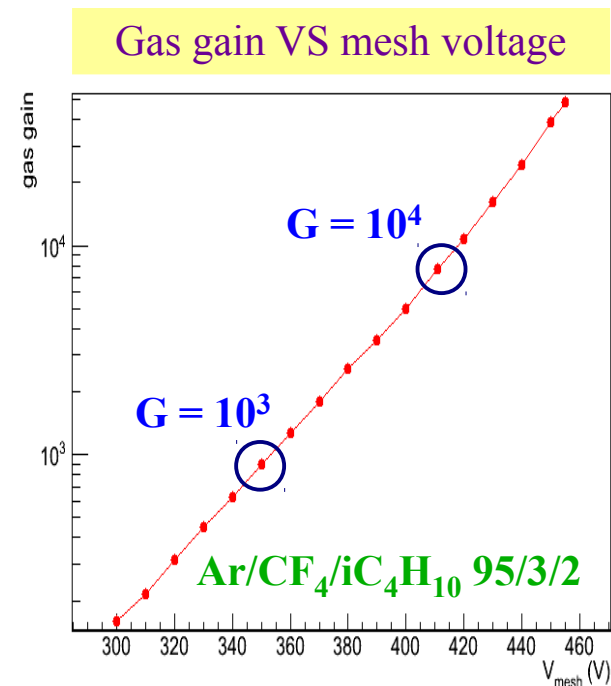
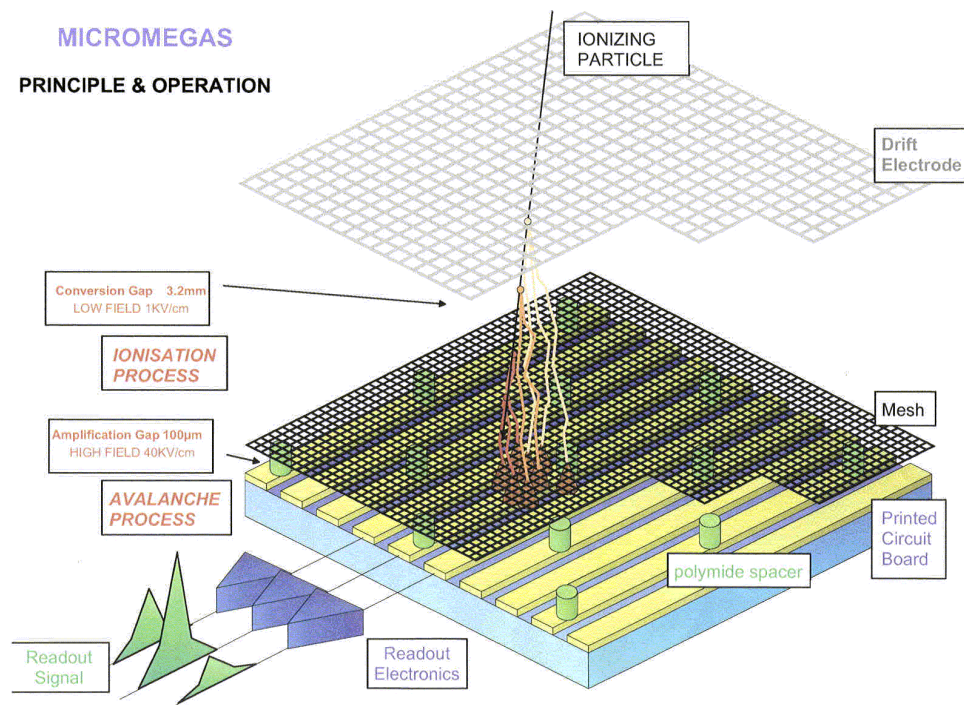
Narrow avalanches + fast collection of avalanche charge + moderate gas gains  
→ **no space charge effects**

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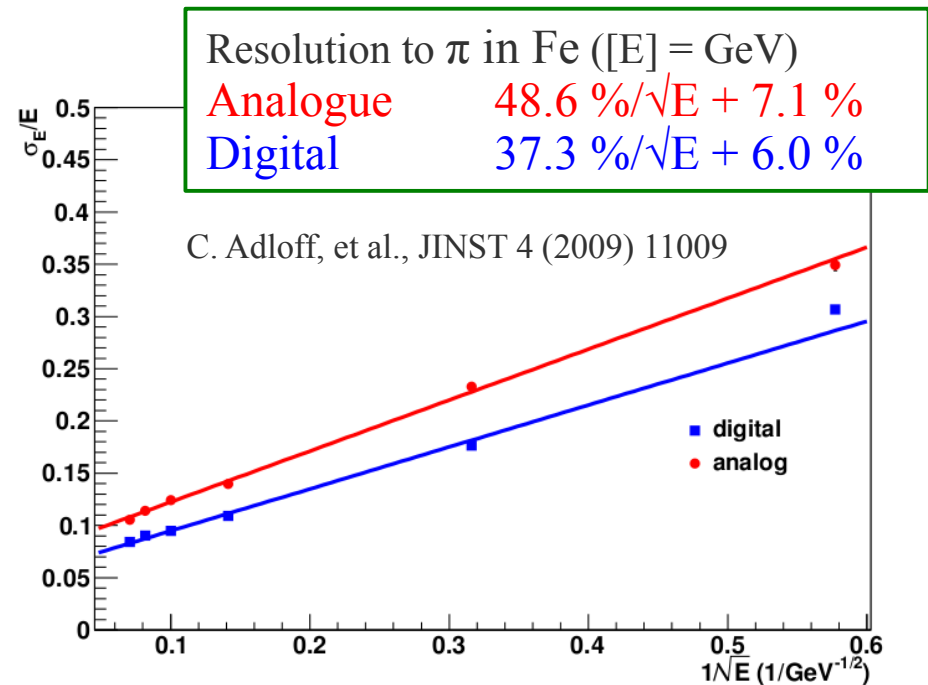
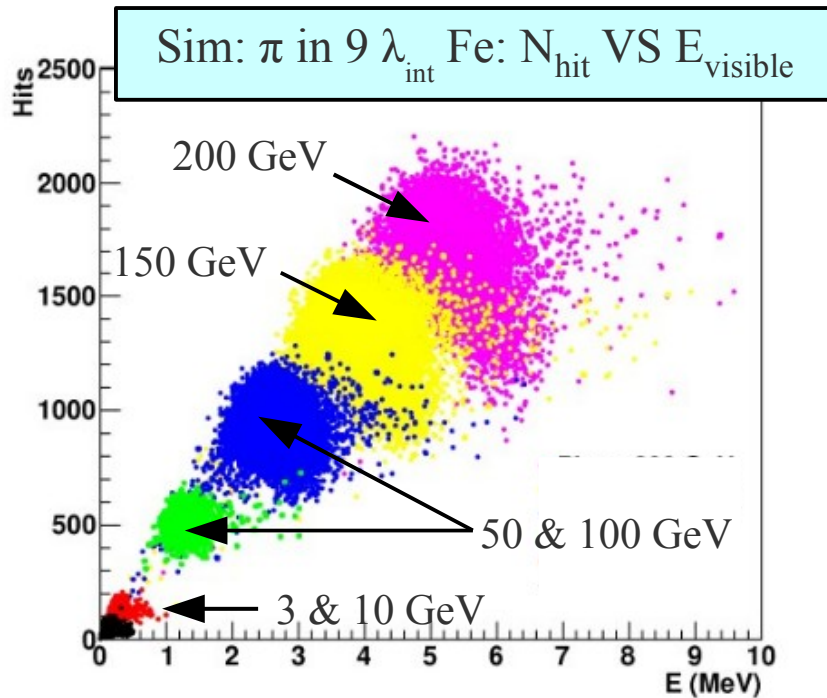


Narrow avalanches + fast collection of avalanche charge + moderate gas gains  
→ **no space charge effects**

# Micromegas for a sampling HCAL (1/2)

**If cell size  $\ll$  shower transverse size, counting isn't worse than measuring charge...**

Resolution actually better, linearity worse but can be improved with 3 thresholds instead of 1  
**... and should make calibration & monitoring simpler.**



**Use of 3 thresholds & high rate capable**  $\leftarrow$  No space charge

**Neutron signal in H-rich mixtures**  $\leftarrow$  Freedom in gas choice

**Superior imaging capability**  $\leftarrow$  1 particle = 1 hit

**Low-noise**  $\leftarrow$  HV < 500 V, Gain  $\sim O(10^3)$ , weak P/T effect (+1% / K)

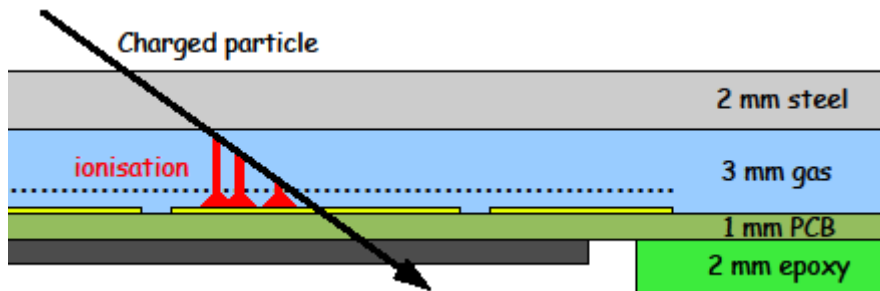
Pros of Micromegas  
 w.r.t. RPC DHCAL

# Micromegas for a sampling HCAL (2/2)

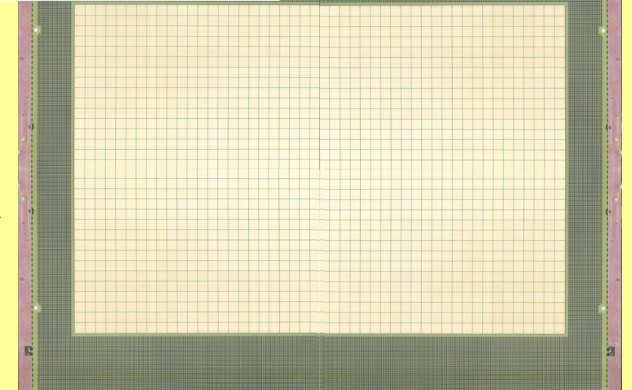
Micromegas is a relatively new technology (1996)  
A lot of R&D work at LAPP to

**Fabricate large area detectors**  
**Basic blocks are called Active Sensor Units (ASU)**  
48x32 cm<sup>2</sup> PCB assembled with minimum dead zones

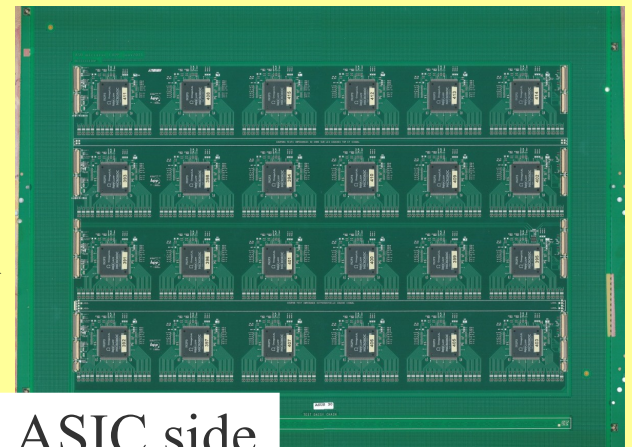
**Reduce chamber thickness**  
Integrate ASIC directly on PCBs



Pad side



ASIC side



**Develop low noise front-end electronics (FEE):** MICROROC (CNRS collaboration LAL/Omega-LAPP)

**Reduce discharge rate and protect FEE**

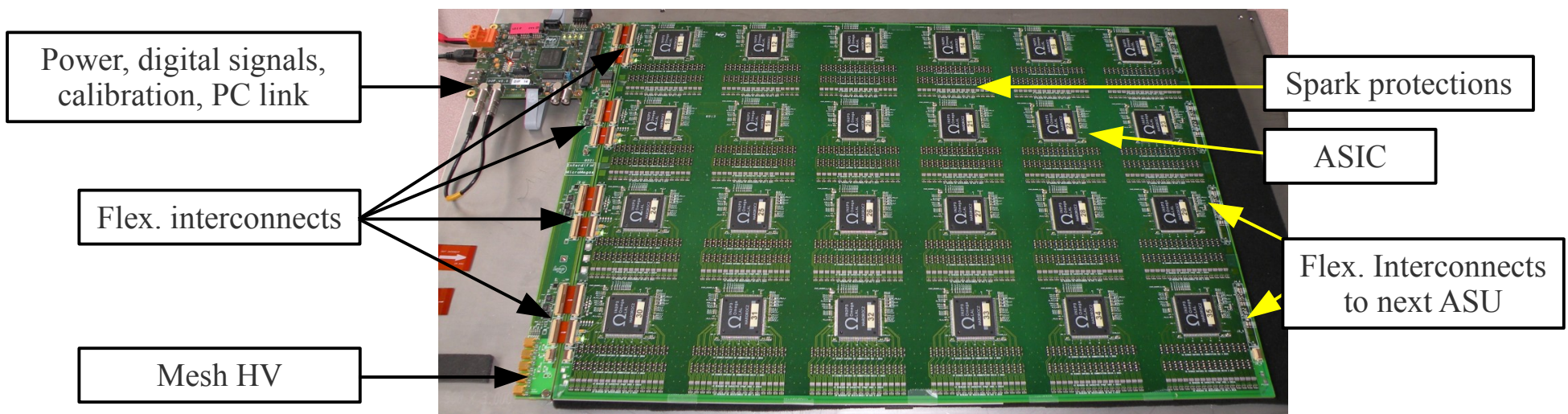
# Detector basic block: Active Sensor Units (ASU)

Contain both the multiplying mesh and front-end readout on a single board.  
→ 1536 channels readout by 24 MICROROC ASIC + external boards

Made in 3 steps: PCB with routing and pads → connect ASIC → laminate Bulk mesh

Flexible interconnection on both sides of ASU allow chaining several of them  
→ **Scalability**

32x48 pads of 1 cm<sup>2</sup> on back side





# Detector front-end chip: MICROROC

**MICROROC is a 64 channel ASIC optimised for the detection of signals of Micro Pattern Gas Detectors (MPGD) such as Micromegas or GEM.**

Charge preamplifier with a **noise of 1500 ENC** only ( $C_{det} = 80$  pF)!  
+ channel-to-channel adjustable threshold

➔ High sensitivity

**2 shapers** followed by **3 discriminators**, timestamping of 200 ns and **127 event depth memory**

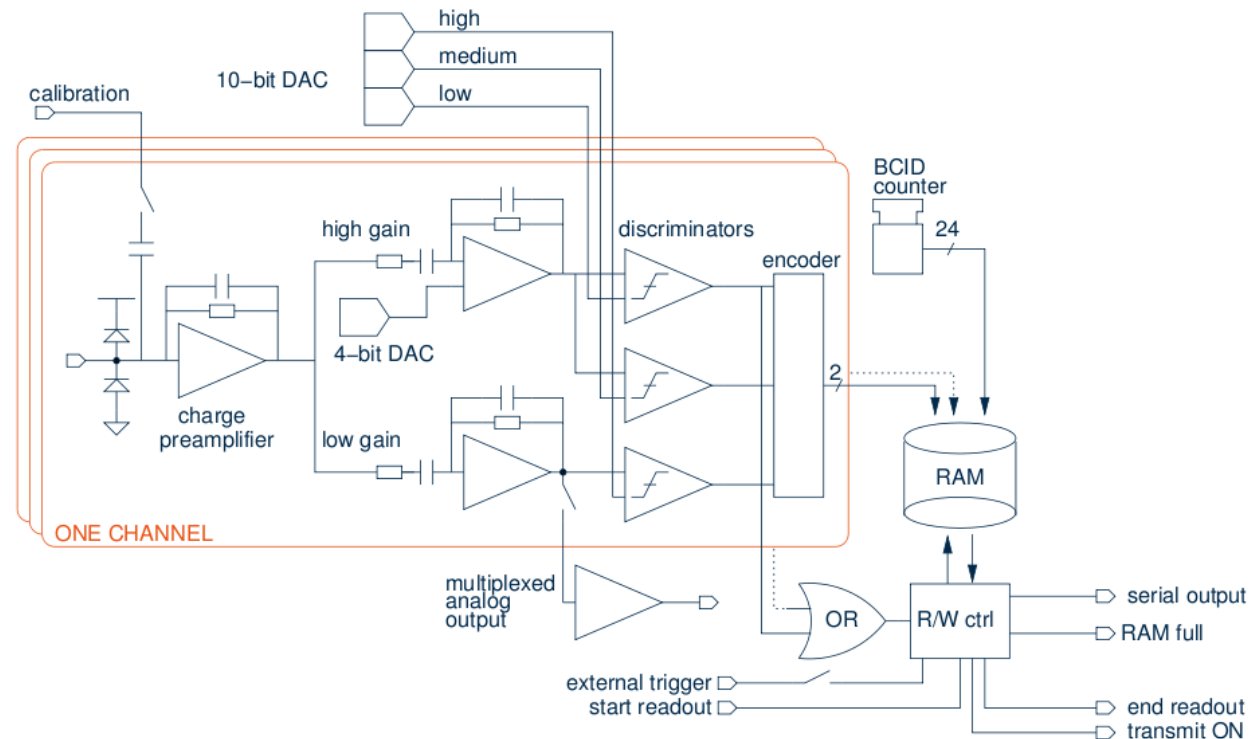
## Protection

Spark protection network in Si

## Consumption

3.75 mW/channel

Can be reduced by power-pulsing



# Test of Active Sensor Units

## Electronics tests : MICROROC calibration

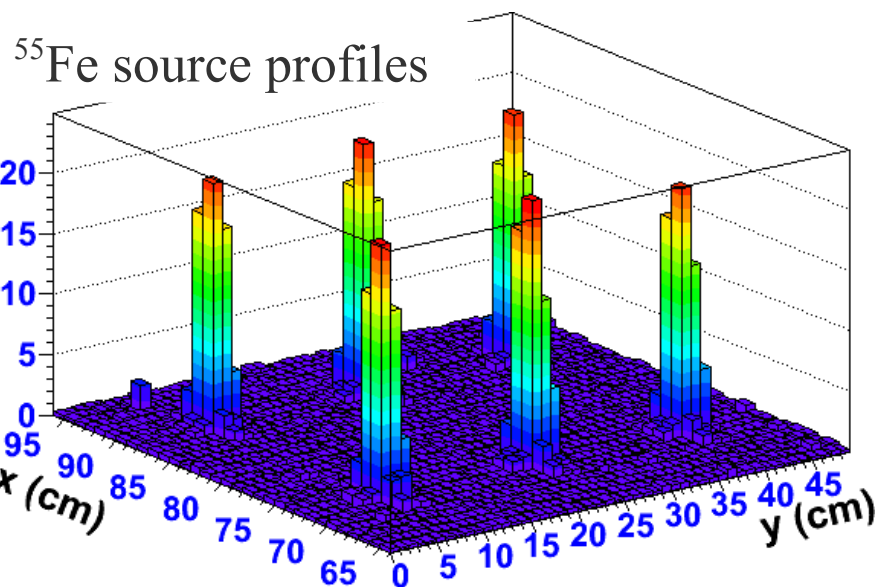
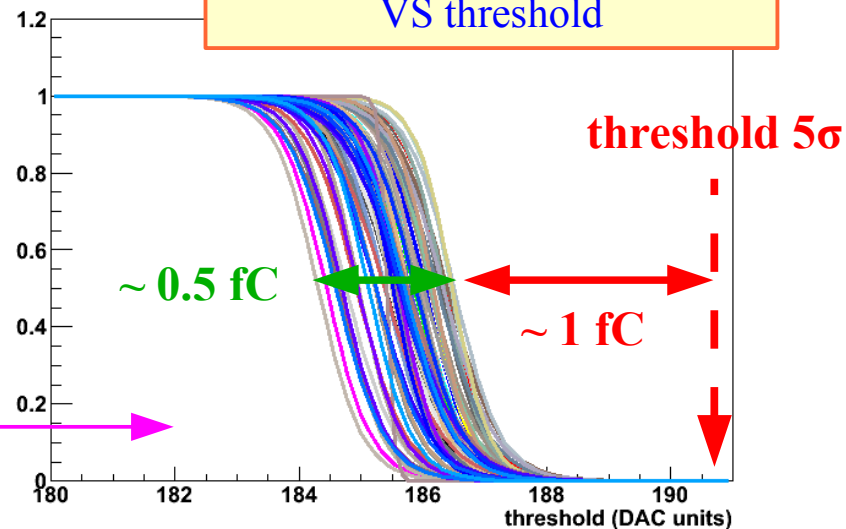
Spread of shaper gains < 2%

**Detection threshold of 1 channel:  $5 \cdot \text{noise} \sim 1 \text{ fC}$**

Add pedestal dispersion of 64 channels  $\sim 0.5 \text{ fC}$

Pedestal dispersion can be reduced by half thanks to channel adjustment bit

## Trigger efficiency @ 0 charge VS threshold



## Full ASU test: $^{55}\text{Fe}$ X-rays in gas

Photopeak ( $230 \text{ e}^-$ ) seen at gas gain of 100 only

Similar counting rate measured on 6 positions / ASU

→ Gas gain of a few  $10^3$  should be enough for MIPs!

# Scaling the detector to 1 m<sup>2</sup>

## 1 ASU of 1 m<sup>2</sup> ?

Technically difficult to fabricate & higher spark current

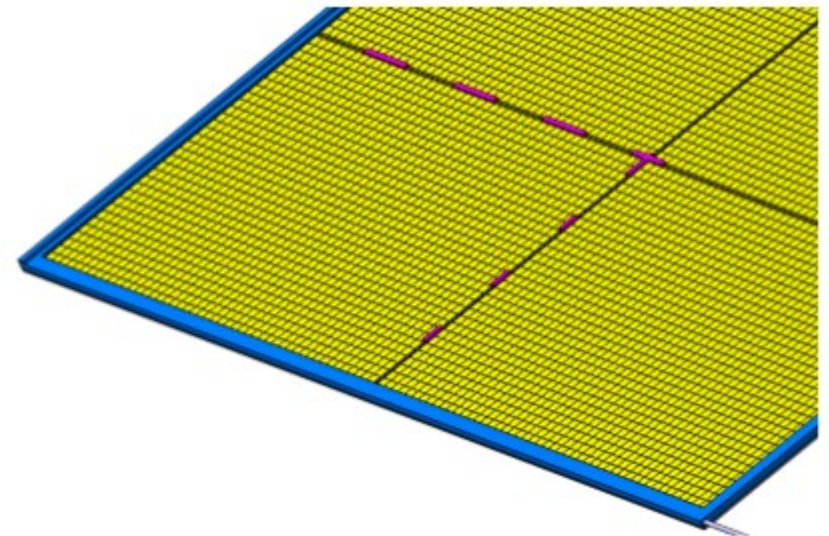
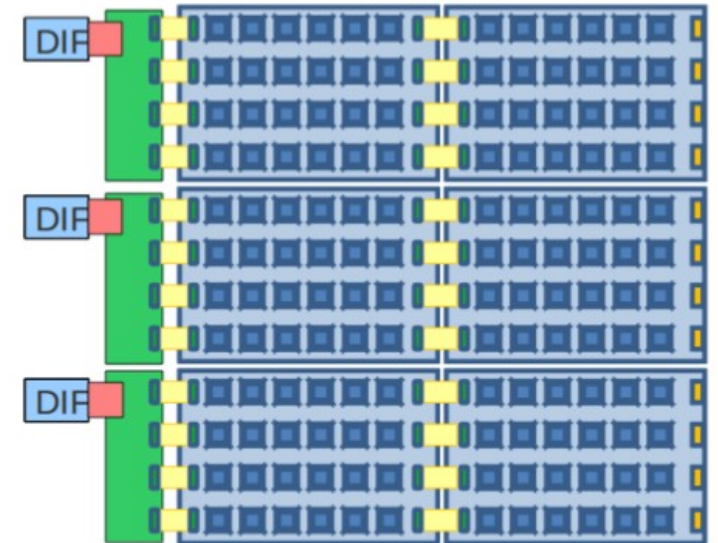
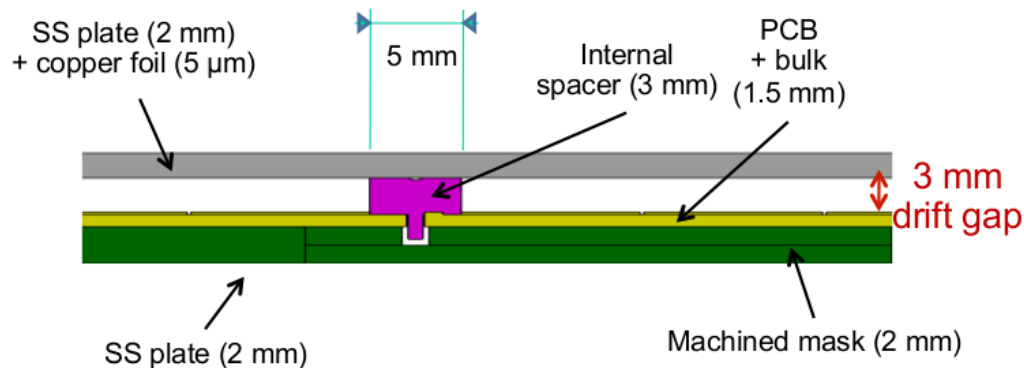
## Instead: 6 ASU inside same gas chamber (9216 channels)

Interconnection by flexible cables

**Minimize dead zone  
while maintaining a constant 3 mm drift gap**

Use 1 mm between ASU for spacers  
Adds up to 2 mm insulating line at ASU edges

→ **2 % dead area**



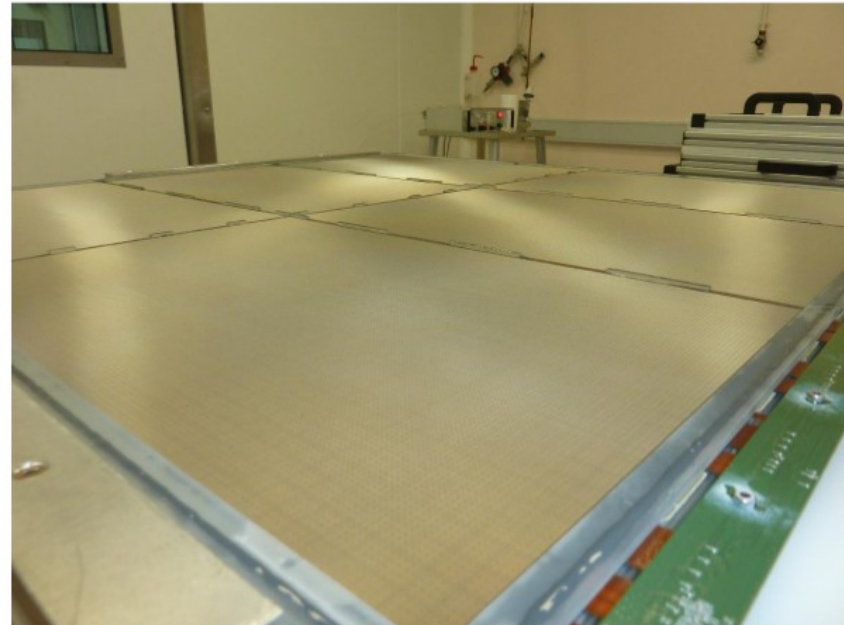
# Micromegas prototype of 1 m<sup>2</sup>

**Assembly takes one week**

First prototype constructed in May 2011, second by end of 2011.

Today, we have enough Active Sensor Units for constructing 2 more.

**We expect to have 4 prototypes by the end of 2012**



# Test beams and studies

## Test beam campaigns

### Standalone (2011)

MIP setup: telescope + 1 prototype

Shower setup: telescope + 1  $\lambda_{\text{int}}$  Fe block + 1 prototype

### Inside RPC-Fe SDHCAL (2011-2012)

Prototypes behind  $\sim 5 \lambda_{\text{int}}$  Fe absorbers (layer # 48-50)

With common DAQ & reconstruction

## Studies

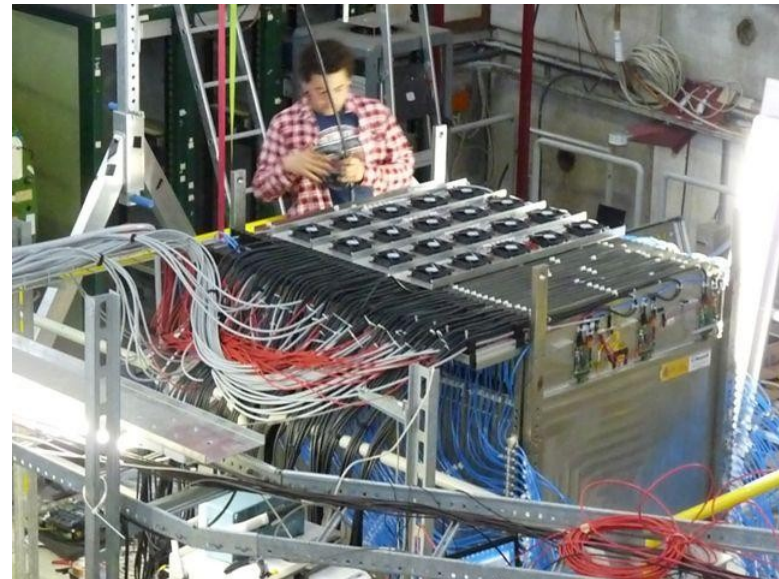
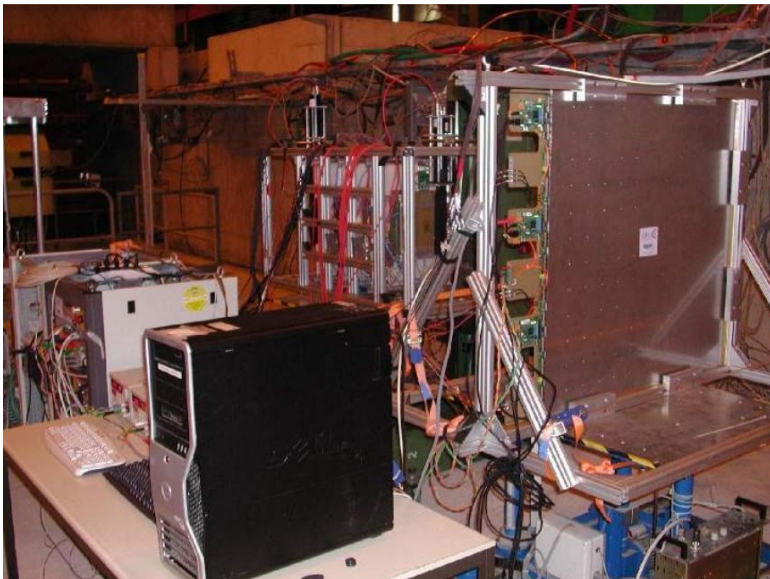
Noise and hit occupancy

Response to MIP

Efficiency & multiplicity

Response to hadron showers

Number of hits, stability, thresholds



# Noise conditions

Without voltage on the mesh and no beam = no activity in gas volume

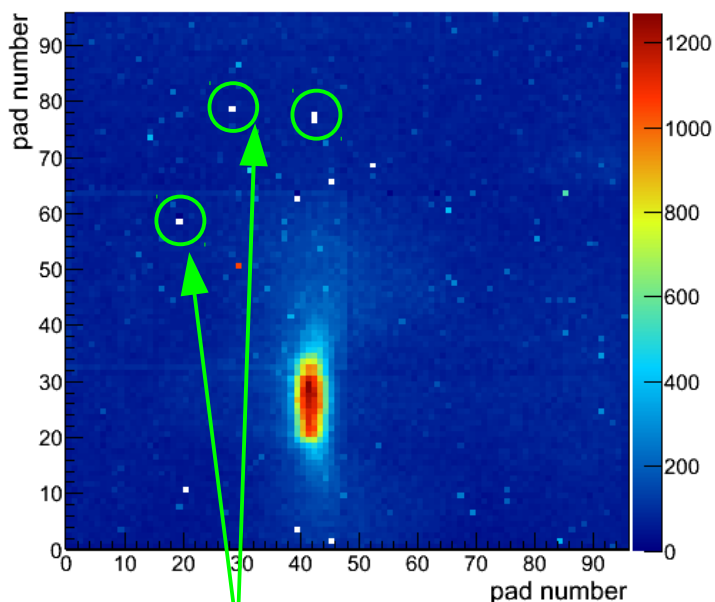
Nois rate  $\sim 0.1$  Hz over all 9216 channels, masking about 10 channels!

With 390 V on the mesh in a 150 GeV/c muon beam (MIP efficiency  $\sim 1$ , cf. next slides)

Occupancy plot shows Beam + cosmic background + a few “hot spots”.

→ Raw data are almost noise free! After cut on time to trigger,  $S/N > 300$ .

## Occupancy Nhit VS XY

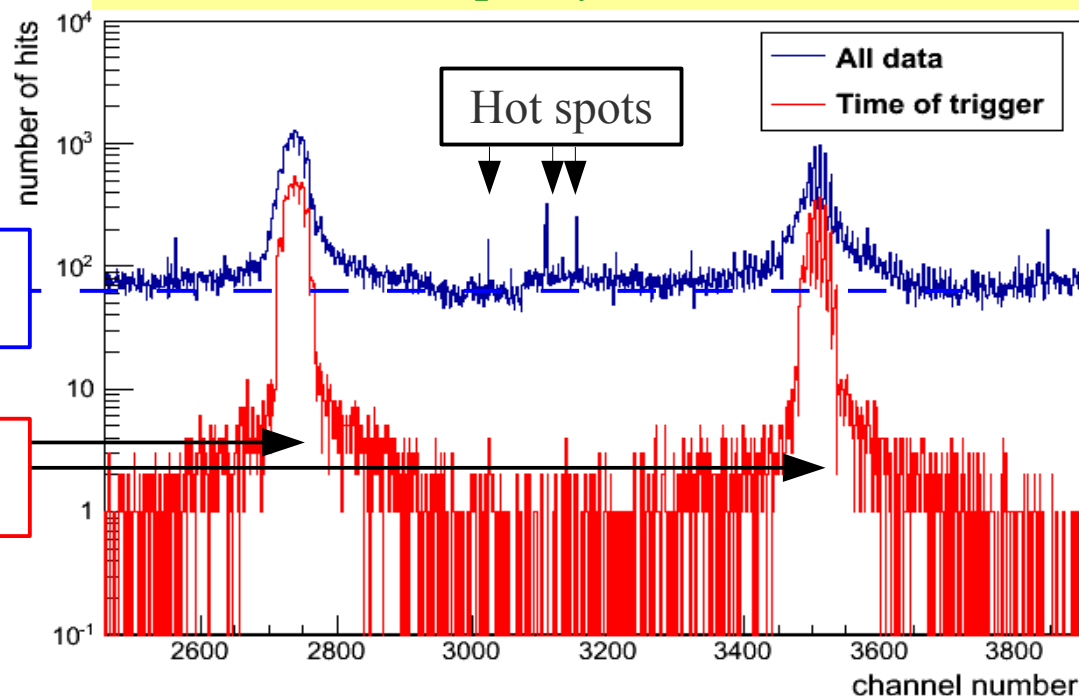


Measked channels

Cosmic background

Beam after time cut

## Channel occupancy Nhit VS channel#



# Noise conditions

Without voltage on the mesh and no beam

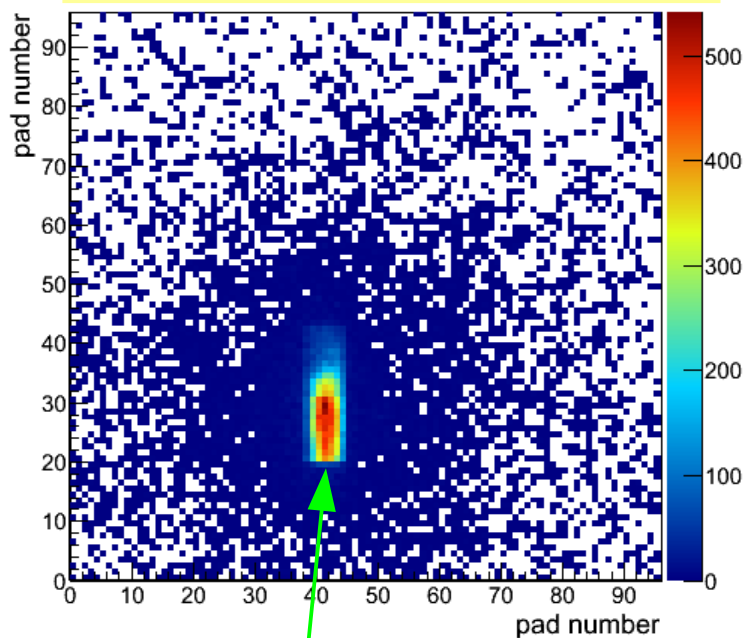
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### Occupancy after time cut

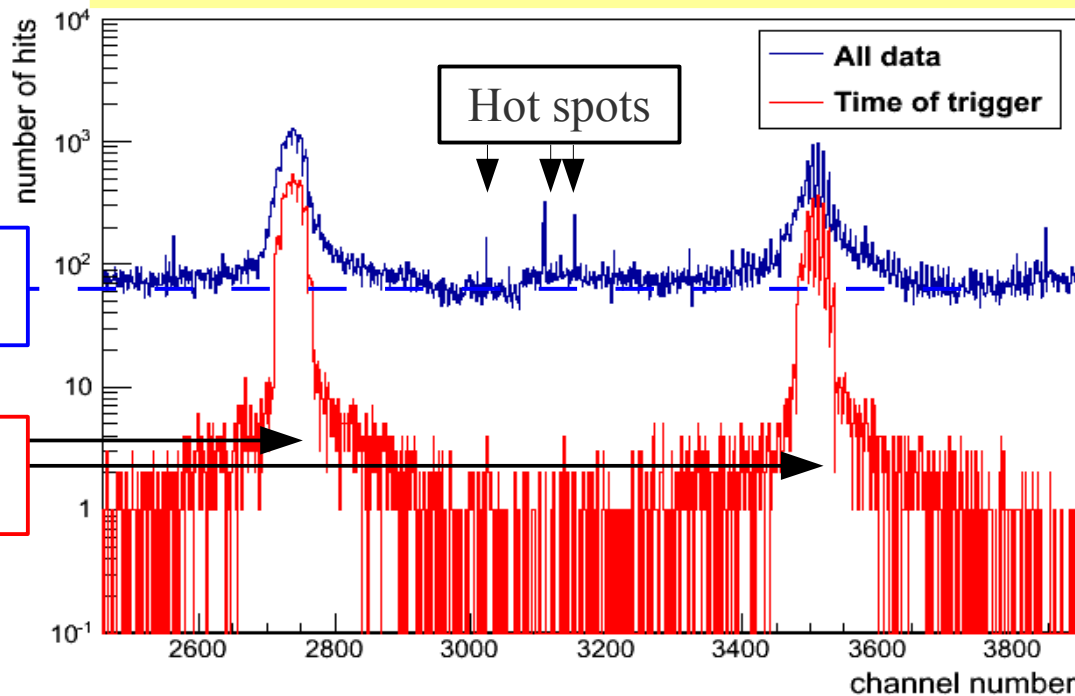


Cosmic background

Beam after time cut

Scintillator shadow

### Channel occupancy Nhit VS channel#



# Response to MIP

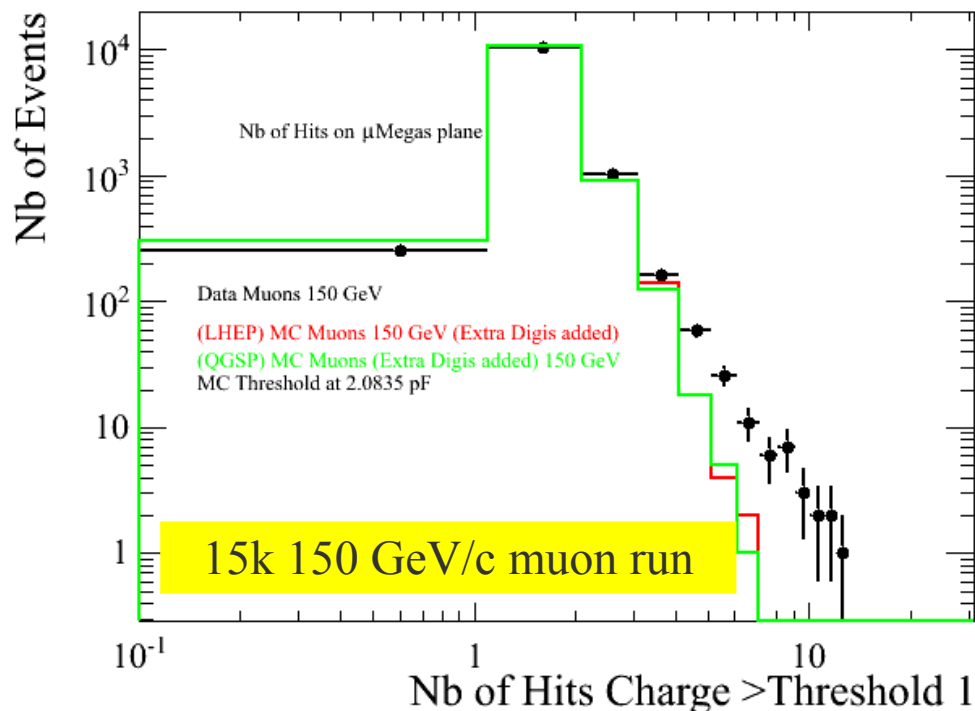
## Method

Extrapolate track from telescope to prototype, given the resolution on the impact position, we count hits in 5x5 pad regions around extrapolated point.

Prototype response = number of hits in 5x5 pad regions

Distribution shows a large peak at 1 and a short tail

→ **high efficiency and low multiplicity**



## Monte Carlo prediction

Use Geant4 for primary charge  
+ simple diffusion model  
+ adjust bin 1 to data

**Tail is hard to reproduce**  
**Still working on it.**



# Efficiency to MIP

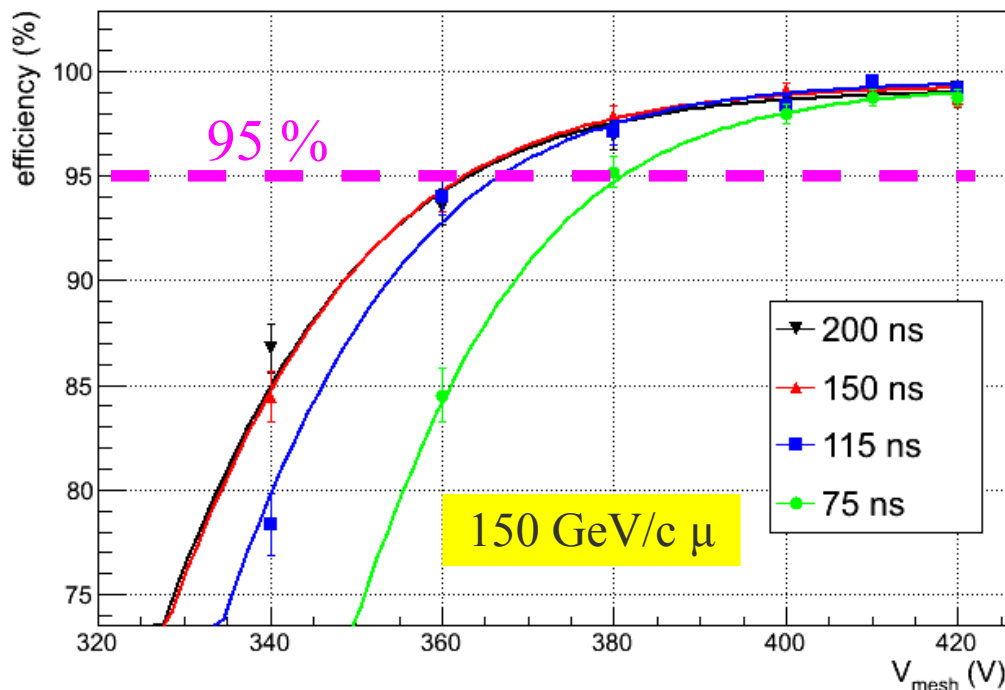
Variation with gas gain (beam directed at center of ASUs over ~ 100 pads)

We use a mixture of Ar/CF<sub>4</sub>/iC<sub>4</sub>H<sub>10</sub> 95/3/2 (non-flammable)

At a gas gain of 1000 (365 V) and using a shaping time > 150 ns, the efficiency reaches 95%

**Cranking up to 3000 (390 V), the efficiency reaches 98 %, this on all 6 ASUs**

## Efficiency VS Vmesh for ≠ shaping times



MICROROC chip

Peaking time can take 4 values from 75-200 ns.

Should be > 150 ns for 128 μm gap Micromegas

**Shorter peaking times could be interesting for GEM/THGEM which deliver only e<sup>-</sup> signal.**

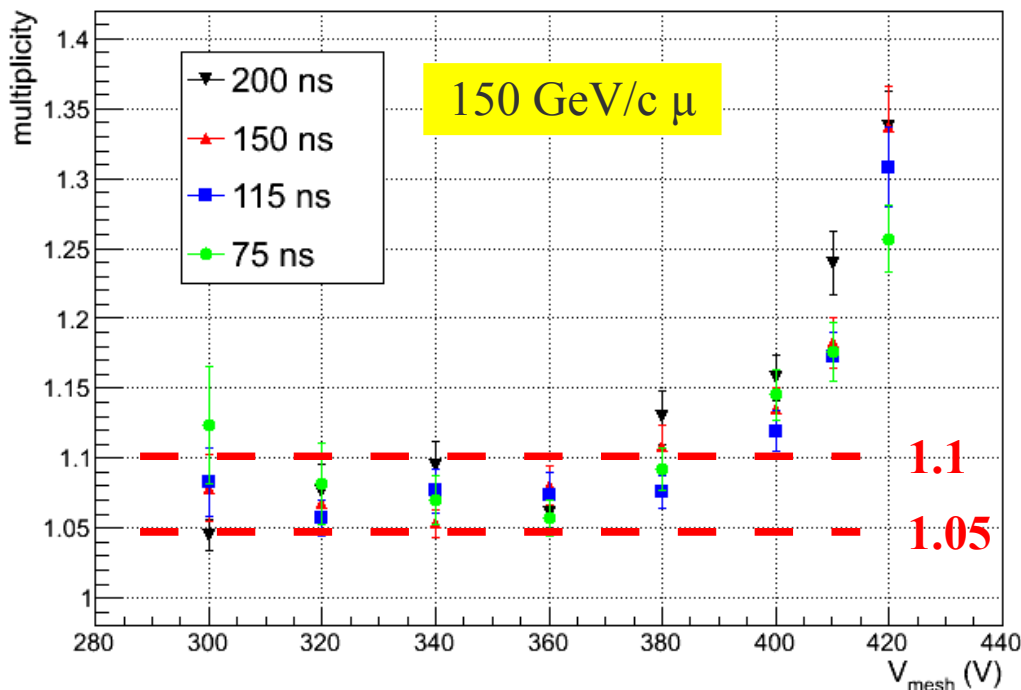
# Multiplicity to MIP

**Lowest hit multiplicity of CALICE gaseous HCAL: remains  $\sim 1.1$  up to 390 V.**

Above 390 V, neighboring pads become sensitive to single primary electrons.

This increases the multiplicity.

## Hit multiplicity VS Vmesh



## Lower limit on multiplicity

Is about 1.05, so we are close.

Is set by the transverse diffusion of the gas and the size of the pads.

# Response uniformity to MIP

An efficiency map was obtained on 2 prototypes (May 2012)

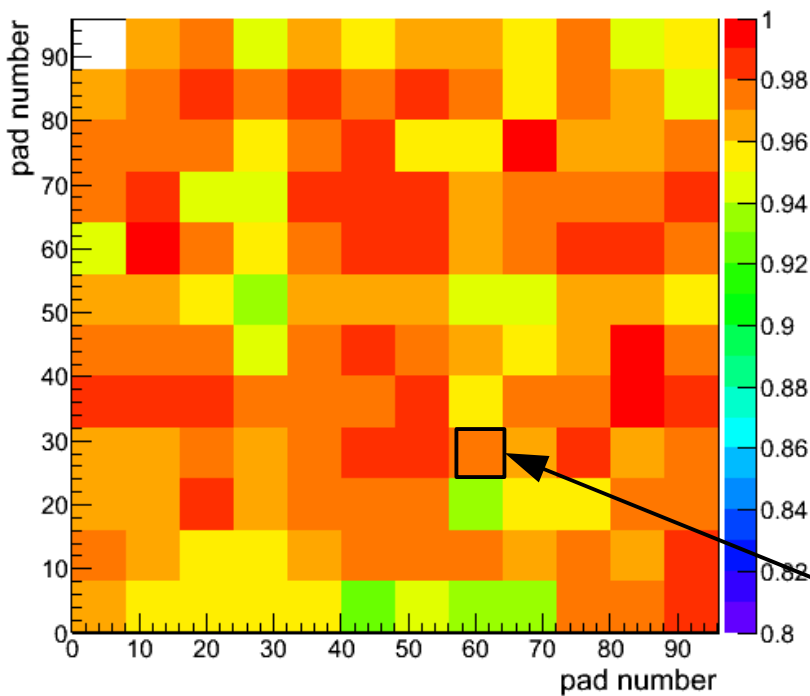
Inside GRPC-Fe SDHCAL after  $5 \lambda_{\text{int}}$ : use GRPC as tracker to find penetrating MIPs (100 GeV/c  $\mu$ ).

**Chamber intrinsic inefficiency from dead area is 2% when MIP traverses between ASU.**

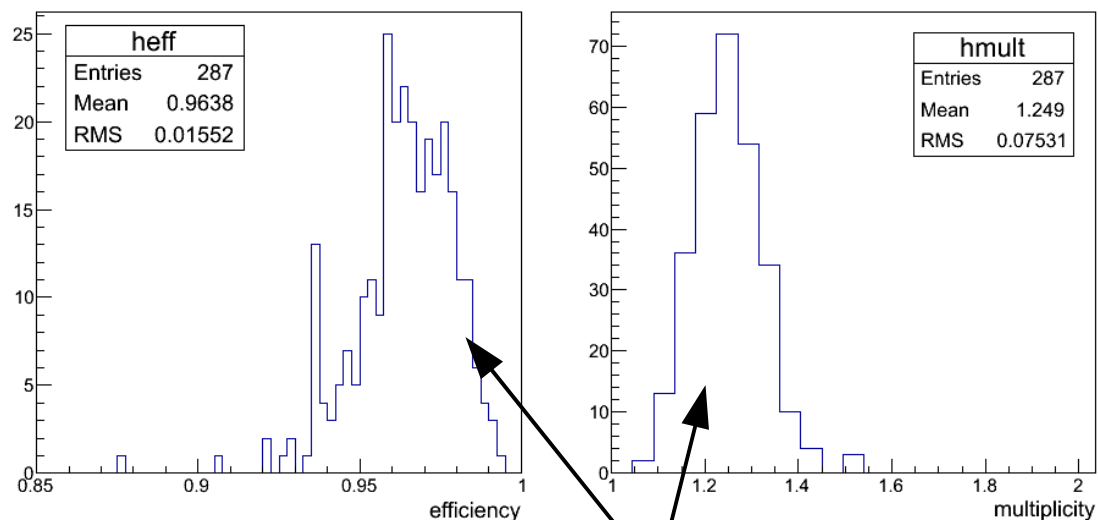
Otherwise, **the average ASIC efficiency ( $8 \times 8 \text{ cm}^2$ ) is  $\sim 96\%$ .**

→ **Drift gap, gas gain and thresholds are well uniform.**

2D efficiency map – 1 prototype



Efficiency and multiplicity – 2 prototypes



1 ASIC =  $8 \times 8 \text{ cm}^2$

287 ASIC

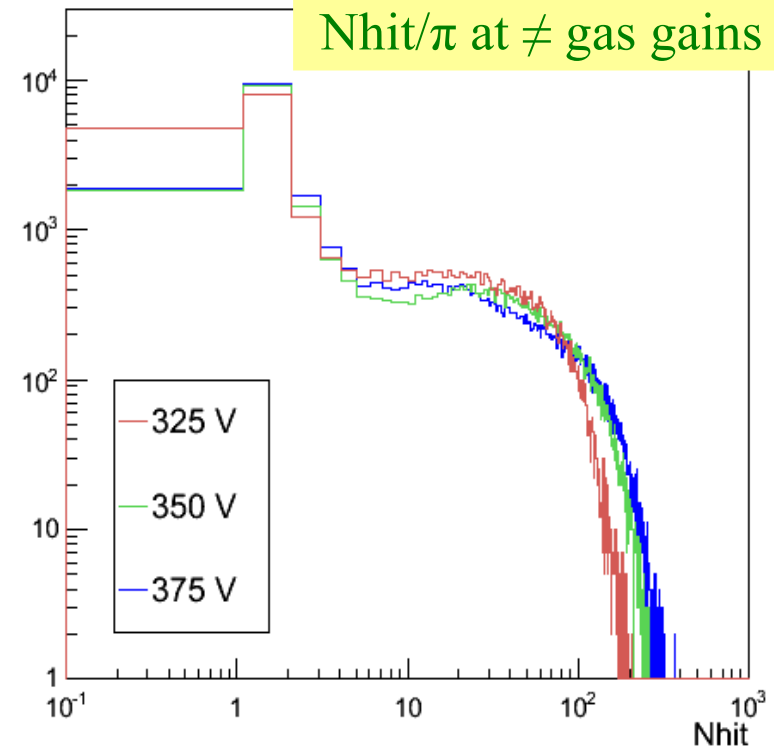
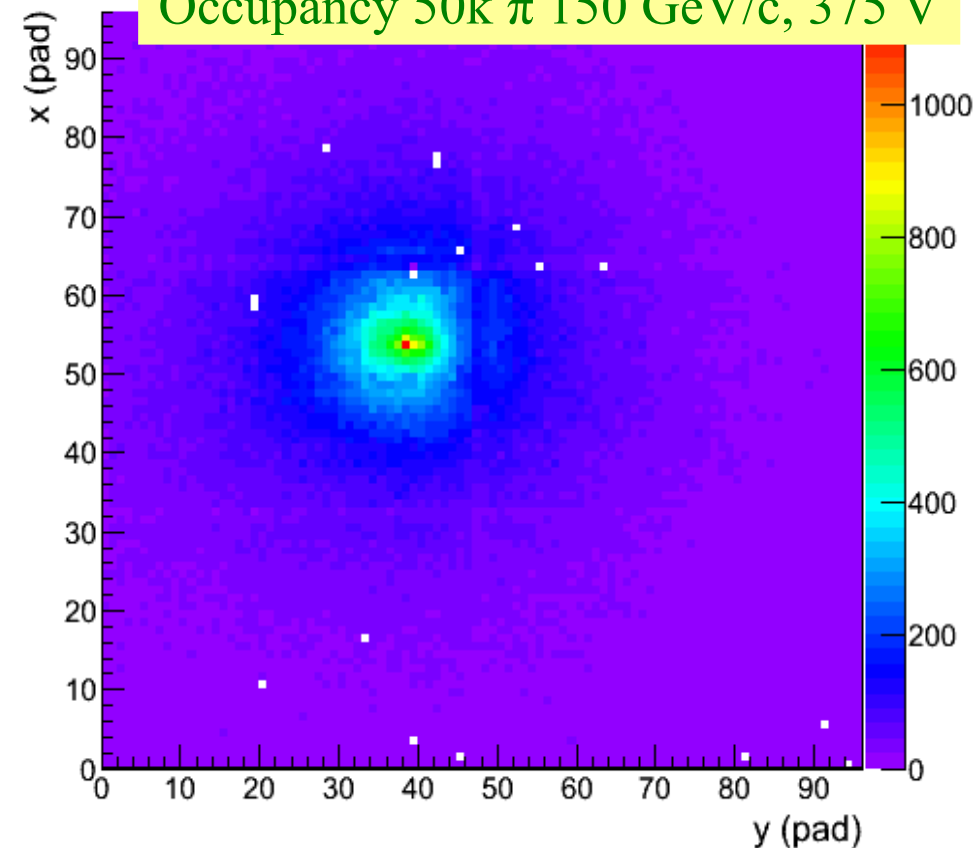
# Response to hadron showers ( $1 \lambda_{\text{int}} \text{ Fe}$ )

Ionising particle spectrum in showers can have  $dE/dx$  larger by orders of magnitude than MIP!  
→ **It is more likely to reach the discharge limit in hadron showers than in a MIP beam.**

Test: direct a 150 GeV/c pion beam at a  $1 \lambda_{\text{int}}$  steel block upstream of the prototype.  
Measure response at various mesh voltages.

Number distribution hardly changes above 350 V!  
→ **Gas gain of  $10^3$  is enough for showers.**  
**Very stable operation.**

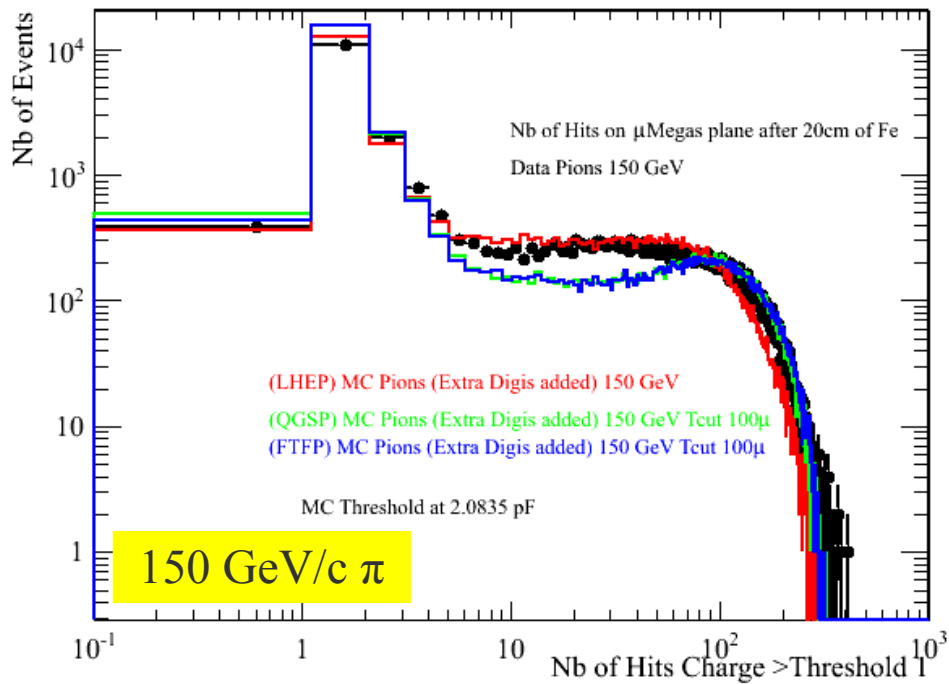
Occupancy 50k  $\pi$  150 GeV/c, 375 V



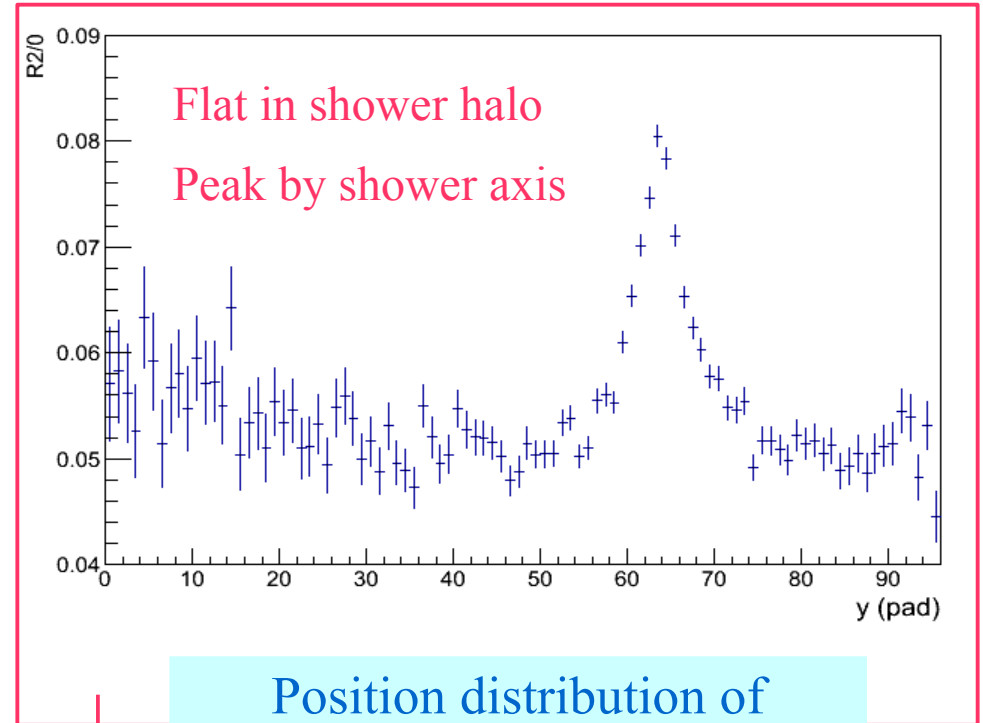
# Response to hadron showers ( $1 \lambda_{\text{int}} \text{ Fe}$ )

## On-going simulation work

We have a digitisation procedure  
and perform first comparison to G4 models.



Nhit above first threshold  
Data & MC, 150 GeV/c  $\pi$  after  $1 \lambda_{\text{int}}$  of Fe



Position distribution of  
 $N_{\text{hit}}(\text{high thr.}) / N_{\text{hit}}(\text{low thr.})$

Semi-digital RO works

Signal pass higher thresholds by the shower axis.

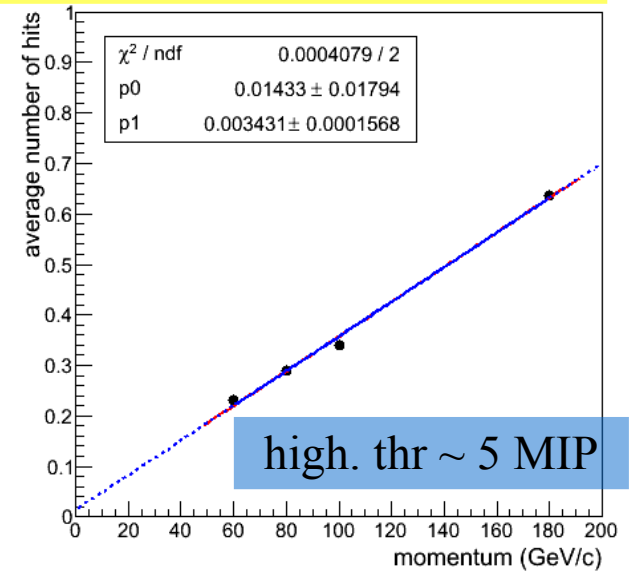
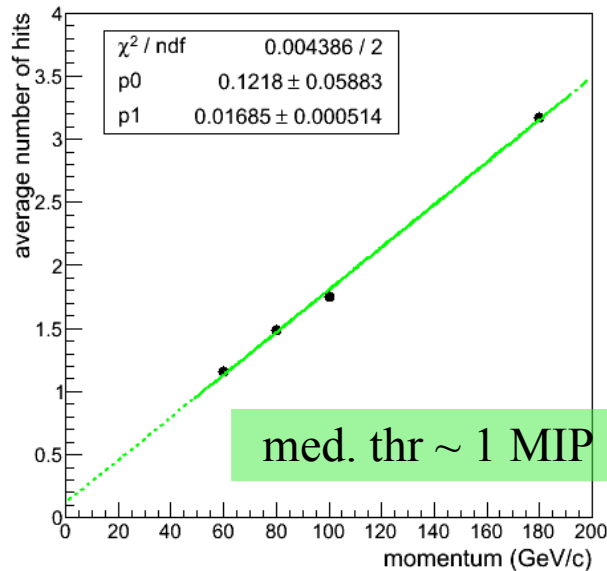
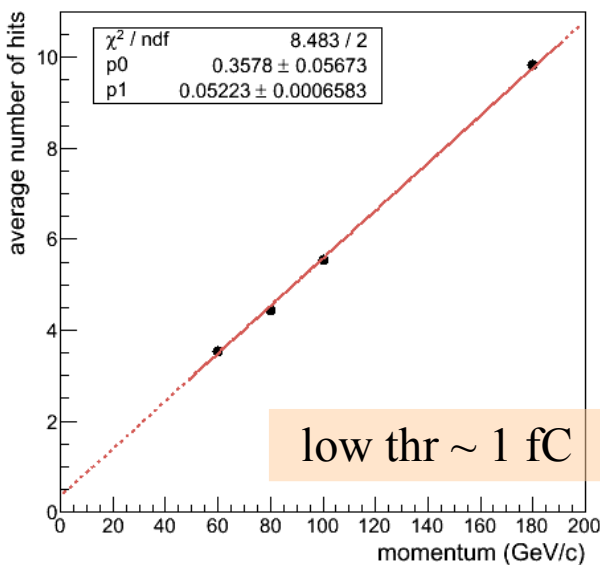
# Response to hadron showers ( $5 \lambda_{\text{int}} \text{ Fe}$ )

## Linearity

At layer #47 of SDHCAL, **linear trend of Nhit with pion energy up to 180 GeV/c.**

This for the 3 thresholds:  $\sim 1$  fC, 1 MIP and 5 MIP.

## Average Nhit @ layer # 47 VS $\pi$ momentum, 50-100k events / point, 60,80,100,180 GeV/c



Good prospect for a full calorimeter.

But next: measure the trends closer to shower max.

→ Test beam of 4 Micromegas in Oct. 2012 inside RPC-SDHCAL: layer # 5, 15, 25 & 35.

# Conclusion on the 1 m<sup>2</sup> prototypes

**A lot of progress since last CALOR conference in 2010!**

**Micromegas prototypes show excellent performance.**

The key is the operation at low gas gain, made possible by the use of MICROROC ASIC.

Nice set of measurements.

Still need to converge on a **complete quantitative understanding** of the test beam results.

**What about true calorimetric measurements in a Micromegas sDHCAL?**

2 DHCAL projects already well on track, difficult to get more Micromegas layers funded...

**This fall: 4 layers inside GRPC SDHCAL at CERN (October).**

Will try to extract as much Micromegas-specific results.

**So, we should focus on improving the technical aspects.**

# Prospects towards LC-like module

## Scalability: transverse dimension

1 m<sup>2</sup> prototype design makes scaling to larger size straightforward.

**With current scheme, ASIC chain can be as long as “3 meters” (i.e. 6 ASU).**

## Thickness: longitudinal dimension

Reduce thickness (or increase sampling) of HCAL and possibly costs.

→ **Embed PCB spark protection networks inside PCB**

OR: at gas gain below  $10^3$ , MICROROC diodes are sufficient ? → remove PCB diodes

**If thin enough: possibly interesting for an W-ECAL**

## Time resolution: 4<sup>th</sup> dimension

Timestamping help to remove background at CLIC: **Implement TDC in MICROROC.**

## Long term operation

Micromegas ages well and handles rates, **weak P/T dependence of signal can be removed.**



Thanks for your attention